onsemi

N-Channel, Logic Level Enhancement Mode Field Effect Transistor NDB5060L

General Description

These logic level N–Channel enhancement mode power field effect transistors are produced using **onsemi**'s proprietary, high cell density, DMOS technology. This very high density process has been especially tailored to minimize on–state resistance, provide superior switching performance, and withstand high energy pulses in the avalanche and commutation modes. These devices are particularly suited for low voltage applications such as automotive, DC–DC converters, PWM motor controls, and other battery powered circuits where fast switching, low in–line power loss, and resistance to transients are needed.

Features

- 26 A, 60 V
 - $R_{DS(ON)} = 0.05 \text{ m}\Omega @ V_{GS} = 5 \text{ V}$
 - $R_{DS(ON)} = 0.035 \text{ m}\Omega @ V_{GS} = 10 \text{ V}$
- Critical DC Electrical Parameters Specified at Elevated Temperature
- Rugged Internal Source–Drain Diode Can Eliminate the Need for an External Zener Diode Transient Suppressor
- 175°C Maximum Junction Temperature Rating
- High Density Cell Design for Extremely Low RDS(ON)
- D²PAK Package for Both Through Hole and Surface Mount Applications

ABSOLUTE MAXIMUM RATINGS T_C = 25°C unless otherwise noted

Symbol	Rating	Value	Unit
V _{DSS}	Drain-Source Voltage	60	V
V _{DGR}	Drain-Gate Voltage ($R_{GS} \le 1 \text{ M}\Omega$)	60	V
V _{GSS}	Drain–Source Voltage – Continuous – Nonrepetiti (t _p < 50 μs)	±16 ±25	V
Ι _D	Drain Current – Continuous – Pulsed	26 78	A
PD	Total Power Dissipatiion @ $T_C = 25^{\circ}C$	68	W
	– Derate above 25°C	0.45	W/°C
T _J ,T _{STG}	Operating and Storage Temperature Range	-65 to 175	°C

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

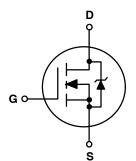
THERMAL CHARACTERISTICS

Symbol	Rating	Value	Unit
$R_{\theta JC}$	Thermal Resistance, Junction-to-Case	2.2	°C/W
R _{θJA}	Thermal Resistance, Junction-to-Ambient	62.5	°C/W

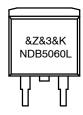


D2PAK-3 (TO-263, 3-LEAD) CASE 418AJ





MARKING DIAGRAM



- &Z = Assembly Plan Code
- &3 = 3-Digit Date Code Code (Year & Week)
- &K = 2-Digits Lot Run Traceability Code

NDB5060L = Specific Device Code

ORDERING INFORMATION

Device	Package	Shipping [†]		
NDB5060L	D2PAK–3 (Pb–Free)	800 / Tape & Reel		

+For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specification Brochure, BRD8011/D.

Symbol	Parameter	Condition	Min	Тур	Max	Unit
DRAIN-SO	URCE AVALANCHE RATINGS (Note 1)					
W _{DSS}	Single Pulse Drain-Source Avalanche Energy	V _{DD} = 30 V, I _D = 26 A	-	-	100	mJ
I _{AR}	Maximum Drain-Source Avalanche Current	•	-	-	26	Α
OFF CHAR	ACTERISTICS					
BV _{DSS}	Drain-Source Breakdown Voltage	$V_{GS} = 0 \text{ V}, I_{D} = 250 \mu\text{A}$	60	-	-	V
I _{DSS}	Zero Gate Voltage Drain Current	$V_{DS} = 60 \text{ V}, V_{GS} = 0 \text{ V}$	-	-	250	μA
		$V_{DS} = 60 \text{ V}, V_{GS} = 0 \text{ V}, T_{J} = 125^{\circ}\text{C}$	-	-	1	mA
I _{GSSF}	Gate-Body Leakage, Forward	V _{GS} = 16 V, V _{DS} = 0 V	-	-	100	nA
I _{GSSR}	Gate-Body Leakage, Reverse	V _{GS} = -16 V, V _{DS} = 0 V	-	-	-100	nA
ON CHARA	CTERISTICS (Note 1)					
V _{GS(th)}	Gate Threshold Voltage	$V_{DS} = V_{GS}, I_{D} = 250 \ \mu A$	1	1.4	2	V
		$V_{DS} = V_{GS}$, $I_D = 250 \ \mu$ A, $T_J = 125^{\circ}$ C	0.65	1	1.5	
R _{DS(ON)}	Static Drain-Source On-Resistance	V _{GS} = 5 V, I _D = 13 A	-	0.042	0.05	Ω
Do(on)		V _{GS} = 5 V, I _D = 13 A, T _J = 125°C	-	0.07	0.08	
		V _{GS} = 10 V, V _{DS} = 13 A	-	0.031	0.035	
I _{D(on)}	On-State Drain Current	V _{GS} = 5 V, V _{DS} = 10 V	26	-	_	Α
9 _{FS}	Forward Transconductance	V _{DS} = 10 V, I _D = 13 A	-	16	_	S
DYNAMIC (CHARACTERISTICS					
C _{iss}	Input Capacitance	V _{DS} = 30 V, V _{GS} = 0 V,	-	840	_	pF
C _{oss}	Output Capacitance	f = 1.0 MHz	-	230	-	pF
C _{rss}	Reverse Transfer Capacitance	1	_	75	_	pF
SWITCHING	G CHARACTERISTICS (Note 1)	•				
t _{D(on)}	Turn – On Delay Time	V _{DD} = 30 V, I _D = 26 A,	-	13	20	nS
tr	Turn – On Rise Time	V _{GS} = 5 V, R _{GEN} = 30 Ω, R _{GS} = 30 Ω	_	200	400	nS
t _{D(off)}	Turn – Off Delay Time	11GS - 00 22	-	45	80	nS
tf	Turn – Off Fall Time	-	_	102	200	nS
Qg	Total Gate Charge	V _{DS} = 24 V, I _D = 26 A, V _{GS} = 5 V	_	17	24	nC
Q _{gs}	Gate-Source Charge		-	4	_	nC
Q _{gd}	Gate-Drain Charge		_	10	_	nC
	URCE DIODE CHARACTERISTICS					
Is	Maximum Continuos Drain-Source Diode Forward Current		_	-	26	А
I _{SM}	Maximum Pulsed Drain-Source Diode Forward Current		-	-	78	А
V _{SD}	Drain-Source Diode Forward Voltage	V _{GS} = 0 V, I _S = 13 A (Note 1)	-	0.9	1.3	V
t _{rr}	Reverse Recovery Time	V _{GS} = 0 V, I _F = 26 A,	-	54	120	ns
		$dI_{F}/dt = 100 A/\mu s$				

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions. 1. Pulse Test: Pulse Width \leq 300 µs, Duty Cycle \leq 2.0%.

TYPICAL CHARACTERISTICS

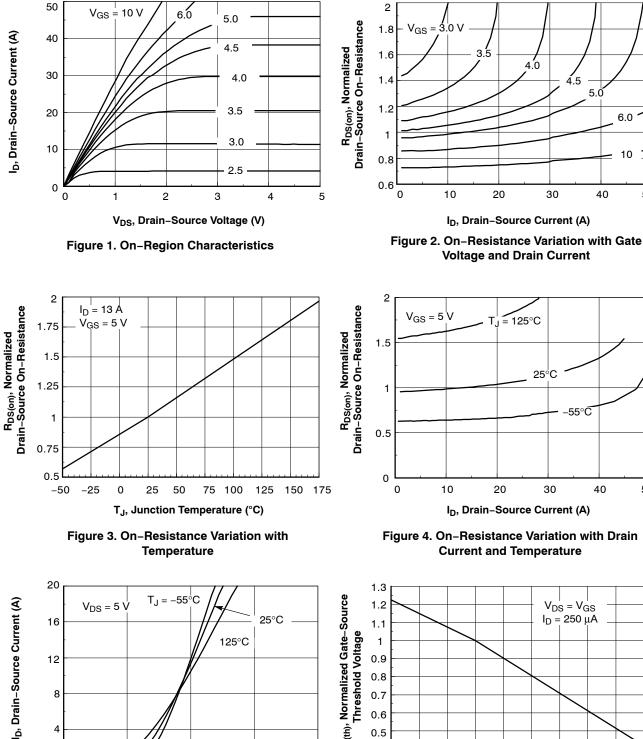


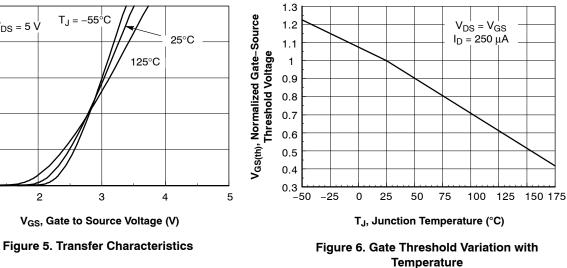
Figure 4. On-Resistance Variation with Drain

6.0

10

50

50

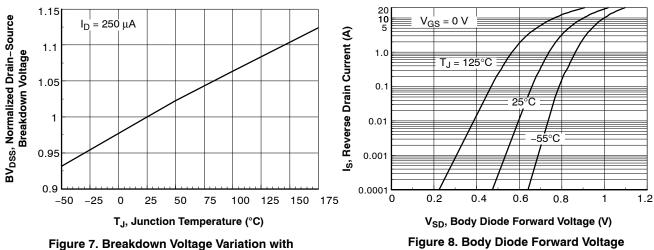


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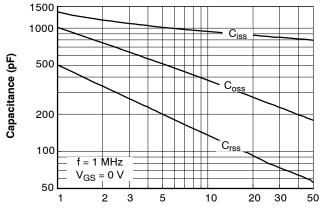
TYPICAL CHARACTERISTICS (Continued)



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I_D = 26 Å





Temperature

V_{DS}, Drain to Source Voltage (V)

Figure 9. Capacitance Characteristics

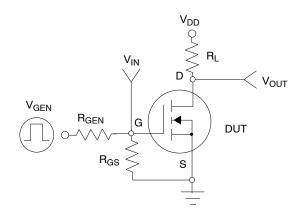




Figure 12. Switching Waveforms

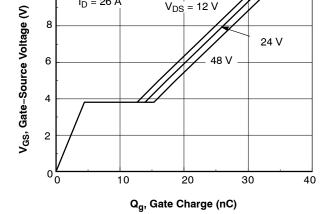
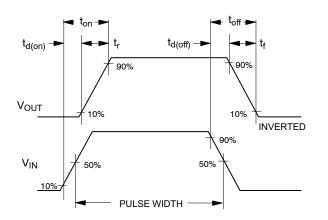
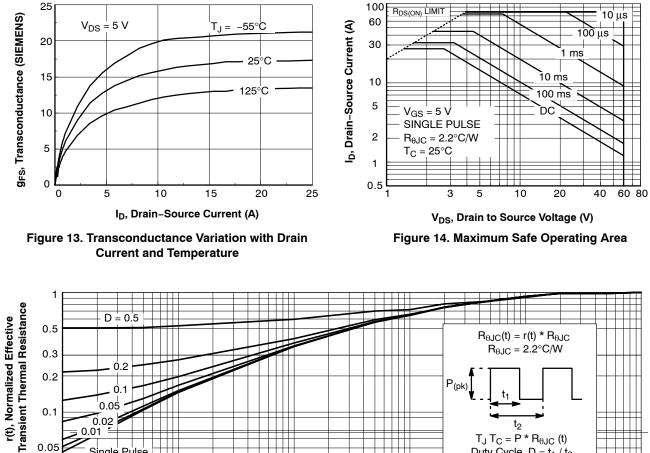
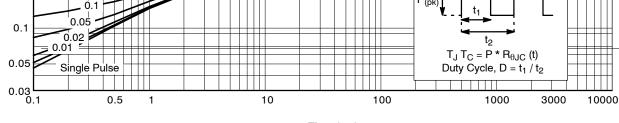


Figure 10. Gate Charge Characteristics



TYPICAL CHARACTERISTICS (Continued)



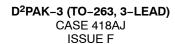


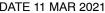
t₁ , Time (ms)

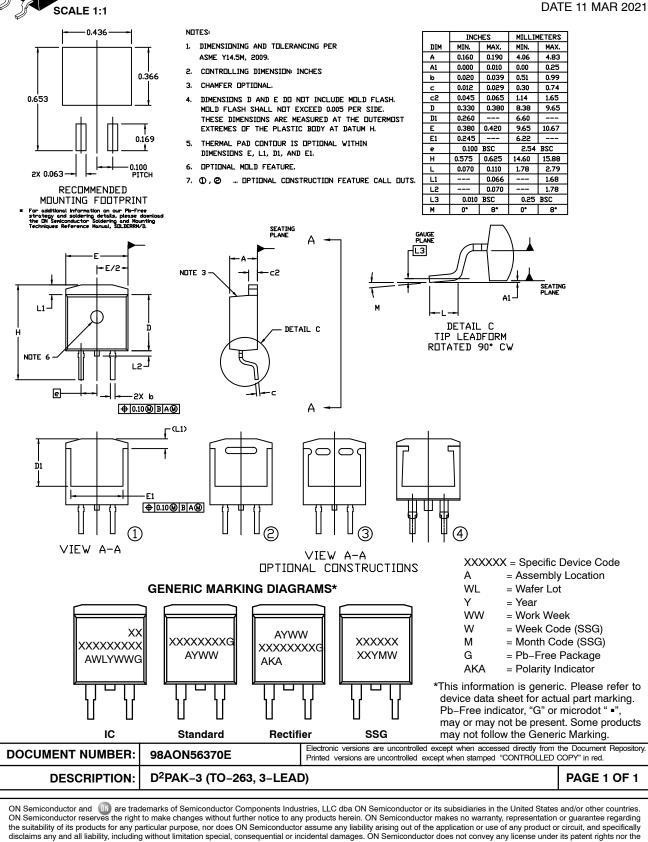
Figure 15. Transient Thermal Response Curve

MECHANICAL CASE OUTLINE PACKAGE DIMENSIONS









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